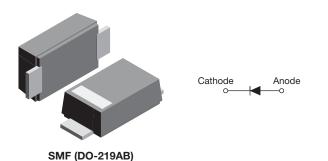
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Hyperfast Rectifier, 1 A FRED Pt[®]



PRODUCT SUMMARY				
Package	DO-219AB (SMF)			
I _{F(AV)}	1 A			
V _R	200 V			
V _F at I _F	0.93 V			
t _{rr}	25 ns			
T _J max.	175 °C			
Diode variation	Single die			

FEATURES

- Hyperfast recovery time, reduced Q_{rr}, and soft recovery
- 175 °C maximum operating junction temperature
- Specific for output and snubber operation
- Low forward voltage drop
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified, meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in snubber, boost, lighting, piezo-injection, as high frequency rectifiers and freewheeling diodes.

The extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element.

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Peak repetitive reverse voltage	V _{RRM}		200	V
Average rectified forward current	I _{F(AV)}	$T_{C} = 160 \ ^{\circ}C \ ^{(1)}$	1	٨
Non-repetitive peak surge current	I _{FSM}	T _J = 25 °C	40	A
Operating junction and storage temperatures	T _J , T _{Stg}		-65 to 175	°C

Note

(1) Device on PCB with 8 mm x 16 mm soldering lands

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	200	-	-	
Forward voltage	VF	I _F = 1 A	-	0.87	0.93	V
i orward voltage	۷F	I _F = 1 A, T _J = 125 °C	-	0.74	0.8	
Reverse leakage current	I _R	$V_{R} = V_{R}$ rated	-	-	2	
		$T_J = 125 \ ^{\circ}C, V_R = V_R \text{ rated}$	-	1	8	μA
Junction capacitance	CT	V _R = 200 V	-	5	-	pF

 Revision: 19-Nov-14
 Document Number: 94877

 For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com
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DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25$ °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	26	-	
	+	I _F = 0.5 A, I _R = 1 A, I _{rr} = 0.25 A		-	-	25	
neverse recovery time	Reverse recovery time t _{rr}	T _J = 25 °C		-	16	-	ns
		T _J = 125 °C		-	23	-	
Peak recovery current I _{RRM}	T _J = 25 °C	I _F = 1 A dI _F /dt = 200 A/μs V _R = 160 V	-	1.6	-	А	
	T _J = 125 °C		-	2.5	-	A	
Reverse recovery charge Q _{rr}	T _J = 25 °C		-	13	-	nC	
	T _J = 125 °C		-	30	-		

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T _J , T _{Stg}		-65	-	175	°C
Thermal resistance, junction to case	R _{thJC}	Device mounted on PCB with 8 mm x 16 mm soldering lands	-	-	17	°C AN
Thermal resistance, junction to ambient	R _{thJA}	Device mounted on PCB with 2 mm x 3.5 mm soldering lands	-	-	140	°C/W
Approvimeto weight				0.015		g
Approximate weight				0.0005		oz.
Marking device		Case style SMF (DO-219AB)		D	Η	•

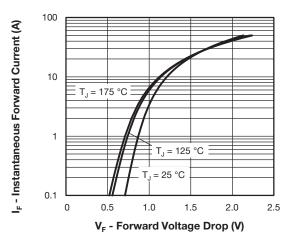


Fig. 1 - Typical Forward Voltage Drop Characteristics

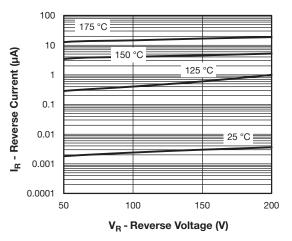


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



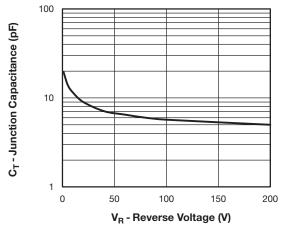


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

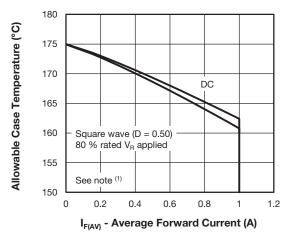


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current

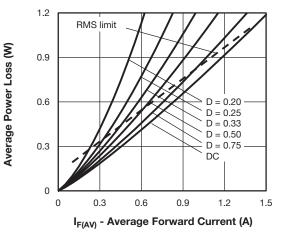


Fig. 5 - Forward Power Loss Characteristics

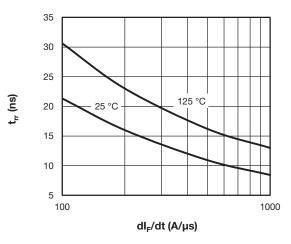


Fig. 6 - Typical Reverse Recovery Time vs. dI_F/dt

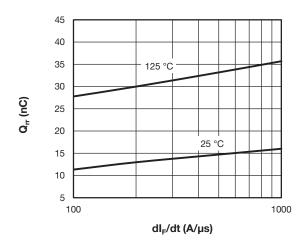


Fig. 7 - Typical Stored Charge vs. dl_F/dt

Note

⁽¹⁾ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;

 $\begin{array}{l} \mathsf{Pd} = \mathsf{Forward} \; \mathsf{Power} \; \mathsf{Loss} = \mathsf{I}_{\mathsf{F}(\mathsf{AV})} \; x \; \mathsf{V}_{\mathsf{FM}} \; at \; (\mathsf{I}_{\mathsf{F}(\mathsf{AV})}/\mathsf{D}) \; (\mathsf{see} \; \mathsf{Fig.} \; 6); \\ \mathsf{Pd}_{\mathsf{REV}} = \mathsf{Inverse} \; \mathsf{Power} \; \mathsf{Loss} = \mathsf{V}_{\mathsf{R1}} \; x \; \mathsf{I}_{\mathsf{R}} \; (1 - \mathsf{D}); \; \mathsf{I}_{\mathsf{R}} \; at \; \mathsf{V}_{\mathsf{R1}} = \mathsf{rated} \; \mathsf{V}_{\mathsf{R}} \\ \end{array}$

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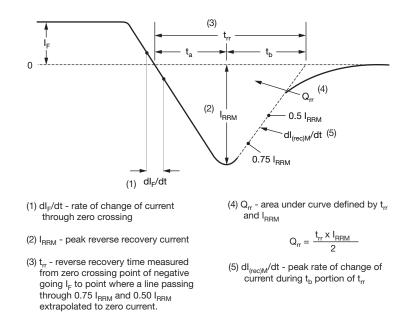
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VS-1EFH02WHM3

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Fig. 8 - Reverse Recovery Waveform and Definitions

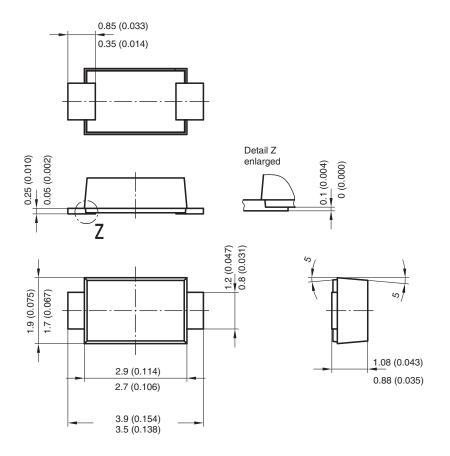
ORDERING INFORMATION (Example)					
PREFERRED P/N	QUANTITY PER REEL	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION		
VS-1EFH02WHM3-18	10 000	10 000	13"diameter plastic tape and reel		

LINKS TO RELATED DOCUMENTS				
Dimensions www.vishay.com/doc?95572				
Part marking information	www.vishay.com/doc?95563			
Packaging information	www.vishay.com/doc?95577			

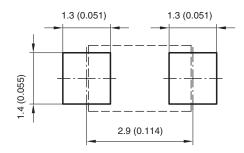


DO-219AB (SMF)

DIMENSIONS in millimeters (inches)



Foot print recommendation:



Created - Date: 15. February 2005 Rev. 3 - Date: 13. March 2007 Document no.:S8-V-3915.01-001 (4) 17247



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